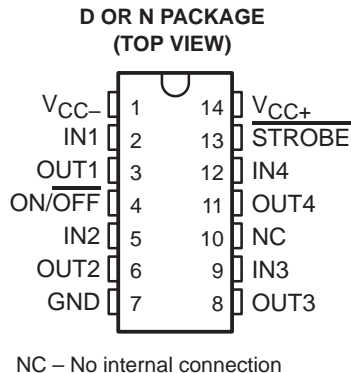


LT1030C QUADRUPLE LOW-POWER LINE DRIVER

SLLS048F – APRIL 1989 – REVISED APRIL 1998

- Low Supply Voltage . . . ± 5 V to ± 15 V
- Supply Current . . . 500 μ A Typical
- Zero Supply Current When Shut Down
- Outputs Can Be Driven ± 30 V
- Output Open When Off (3-State)
- 10-mA Output Drive
- Outputs of Several Devices Can Be Connected in Parallel
- Meets or Exceeds the Requirements of ANSI EIA/TIA-232-F Specifications
- Designed to Be Interchangeable With Linear Technology LT1030



description

The LT1030C is an EIA/TIA-232-F line driver that operates over a ± 5 -V to ± 15 -V supply-voltage range on low supply current. The device can be shut down to zero supply current. Current limiting fully protects the outputs from externally applied voltages of ± 30 V. Since the output swings to within 200 mV of the positive supply and to within 1 V of the negative supply, supply-voltage requirements are minimized.

A major advantage of the LT1030C is the high-impedance output state when the device is off or powered down. This feature allows several different drivers on the same bus.

The device can be used as an EIA/TIA-232-F driver, micropower interface, or level translator, among others.

The LT1030C is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS

PACKAGE	
SMALL OUTLINE (D)	PLASTIC DIP (N)
LT1030CD	LT1030CN

The D package is available taped and reeled. Add the suffix R to the device type (i.e., LT1030CDR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

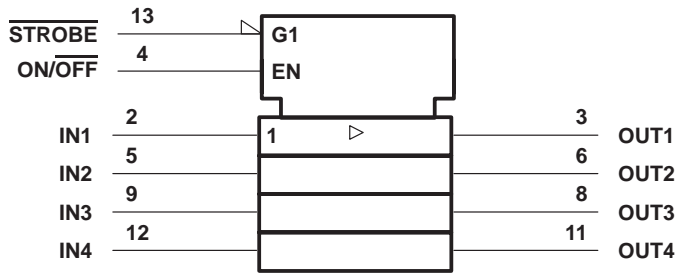
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1998, Texas Instruments Incorporated

LT1030C QUADRUPLE LOW-POWER LINE DRIVER

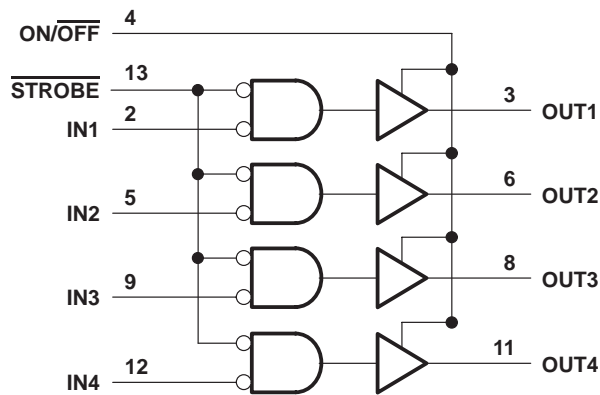
SLLS048F – APRIL 1989 – REVISED APRIL 1998

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram



Terminal Functions

TERMINAL NAME	NO.	DESCRIPTION
GND	7	Ground terminal
IN1 IN2 IN3 IN4	2 5 9 12	Logic inputs. IN _x operate properly on TTL or CMOS levels. Output valid from $V_I = V_{CC-} + 2\text{ V}$ to 15 V. Connect to 5 V when not used.
ON/OFF	4	ON/OFF shuts down the entire circuit. It cannot be left open. For normally on operation, connect between 5 V and 10 V. If V_{IL} is at or near 0.8 V, significant settling time may be required.
OUT1 OUT2 OUT3 OUT4	3 6 8 11	Line driver outputs
STROBE	13	STROBE forces all outputs low. Drive with 3 V. Strobe terminal input impedance is approximately 2 kΩ to GND. Leave STROBE open when not used.
V _{CC+}	14	Positive supply
V _{CC-}	1	Negative supply

LT1030C QUADRUPLE LOW-POWER LINE DRIVER

SLLS048F – APRIL 1989 – REVISED APRIL 1998

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC+} (see Note 1)	0 V to 15 V
Supply voltage range, V_{CC-}	0 V to -15 V
Input voltage range, logic inputs, V_I	V_{CC-} to 25 V
Input voltage range at ON/OFF, V_I	0 V to 12 V
Output voltage range, V_O (any output)	$V_{CC+} - 30$ V to $V_{CC-} + 30$ V
Duration of output short circuit to ± 30 V at (or below) 25°C (see Note 2)	Unlimited
Package thermal impedance, θ_{JA} (see Note 3): D package	127°C/W
N package	78°C/W
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to GND.
 2. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.
 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, V_{CC+}	5	15	V
Supply voltage, V_{CC-}	-5	-15	V
High-level input voltage, V_{IH} (see Note 4)	2	15	V
Low-level input voltage, V_{IL} (see Note 4)		0.8	V
Operating free-air temperature, T_A	0	70	°C

NOTE 4: These V_{IH} and V_{IL} specifications apply only for inputs IN1–IN4. For operating levels for ON/OFF, see Figure 2.

electrical characteristics over operating free-air temperature range, $V_{CC\pm} = \pm 5$ V to ± 15 V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP‡	MAX	UNIT
V_{OM+} Maximum positive peak output voltage swing	$I_O = -2$ mA, $T_A = 25^\circ\text{C}$	$V_{CC+} - 0.3$	$V_{CC+} - 0.1$		V
V_{OM-} Maximum negative peak output voltage swing	$I_O = 2$ mA, $T_A = 25^\circ\text{C}$		$V_{CC-} + 0.9$	$V_{CC-} + 1.4$	V
I_{IH} High-level input current	$V_I \geq 2$ V, $T_A = 25^\circ\text{C}$		2	20	μA
I_{IL} Low-level input current	$V_I \leq 0.8$ V, $T_A = 25^\circ\text{C}$		-10	-20	μA
I_I Input current, ON/OFF	$V_I = 0$		-0.1	-10	μA
	$V_I = 5$ V		30	65	
I_O Output current	$T_A = 25^\circ\text{C}$	5	12		mA
I_{OZ} Off-state output current	$V_O = \pm 15$ V, $T_A = 25^\circ\text{C}$, ON/OFF at 0.4 V		± 2	± 100	μA
I_{CC} Supply current (all outputs low)	$V_I \geq$ at 2.4 V, $I_O = 0$		500	1000	μA
$I_{CC(off)}$ Off-state supply current	ON/OFF at 0.4 V			10	μA
	ON/OFF at 0.1 V		10	150	

‡ All typical values are at $V_{CC\pm} = \pm 12$ V, $T_A = 25^\circ\text{C}$.



LT1030C QUADRUPLE LOW-POWER LINE DRIVER

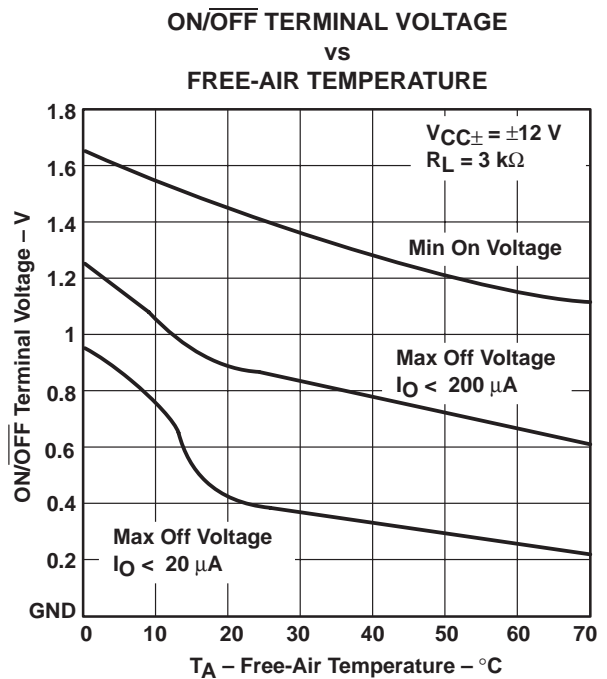
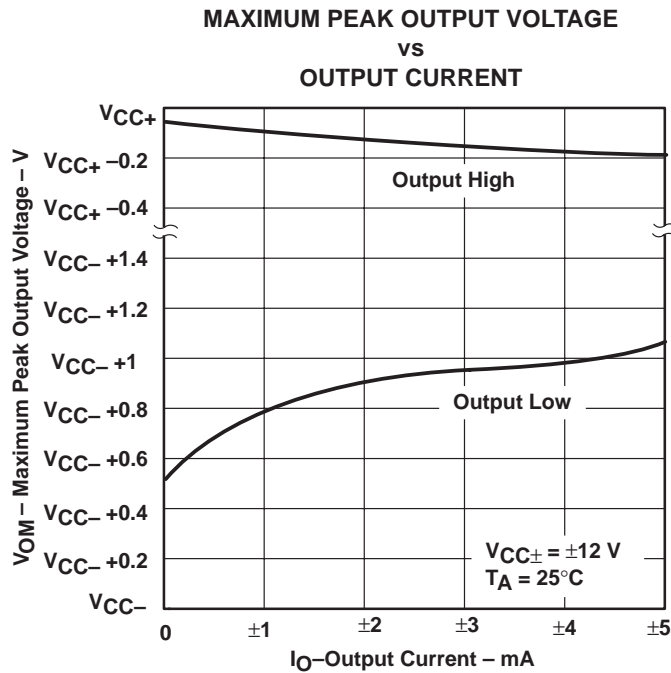
SLLS048F – APRIL 1989 – REVISED APRIL 1998

operating characteristics, $V_{CC\pm} = \pm 5\text{ V to } \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
SR Driver slew rate	$R_L = 3\text{ k}\Omega$, $C_L = 51\text{ pF}$	4	15	30	V/ μs

† All typical values are at $V_{CC\pm} = \pm 12\text{ V}$, $T_A = 25^\circ\text{C}$.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

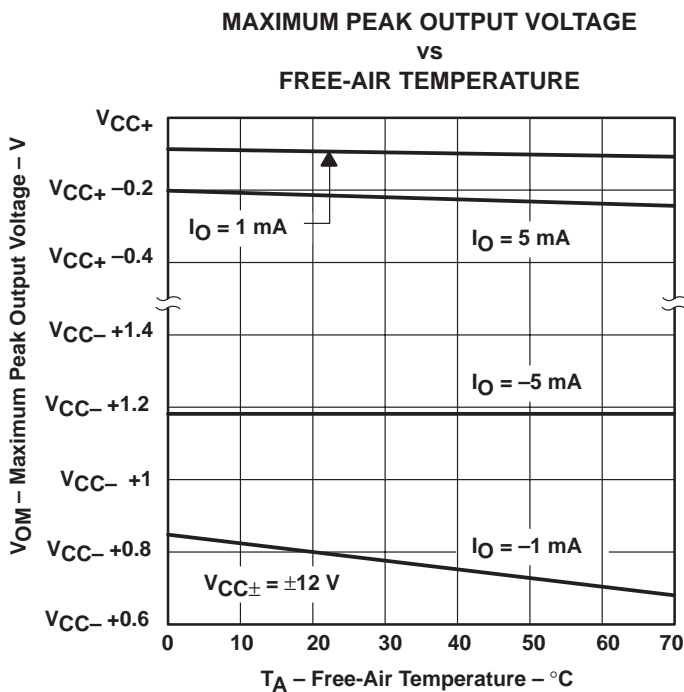


Figure 3

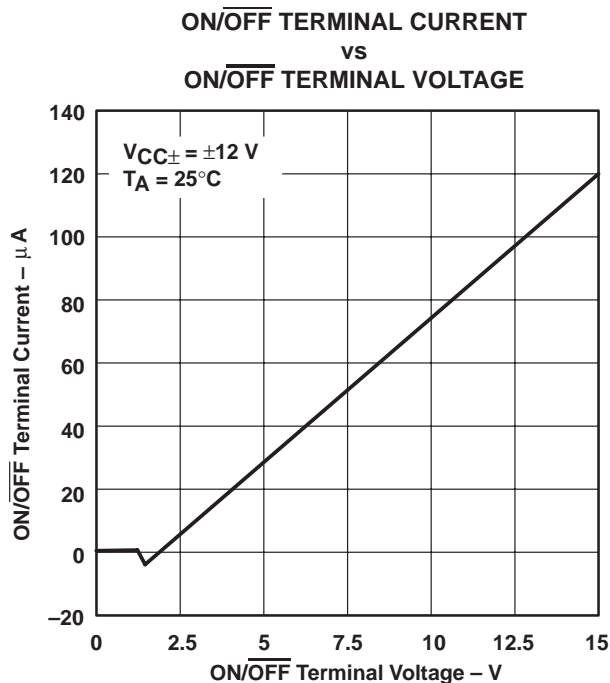


Figure 4

TYPICAL CHARACTERISTICS

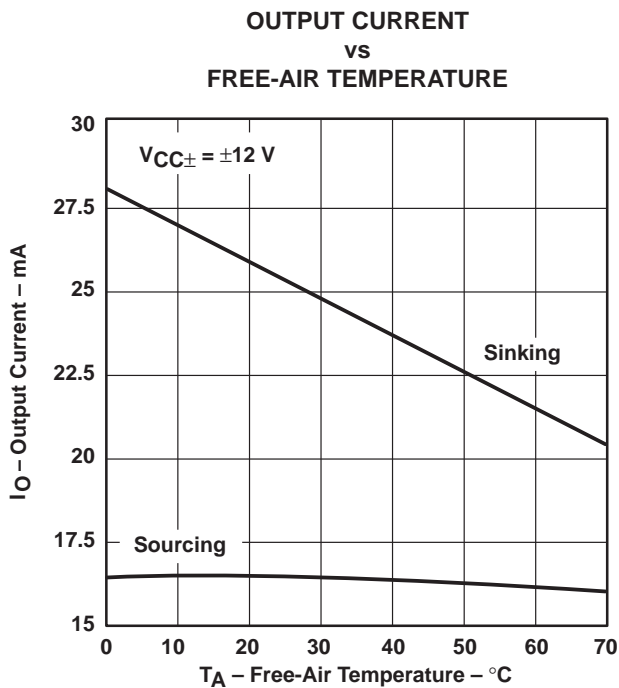


Figure 5

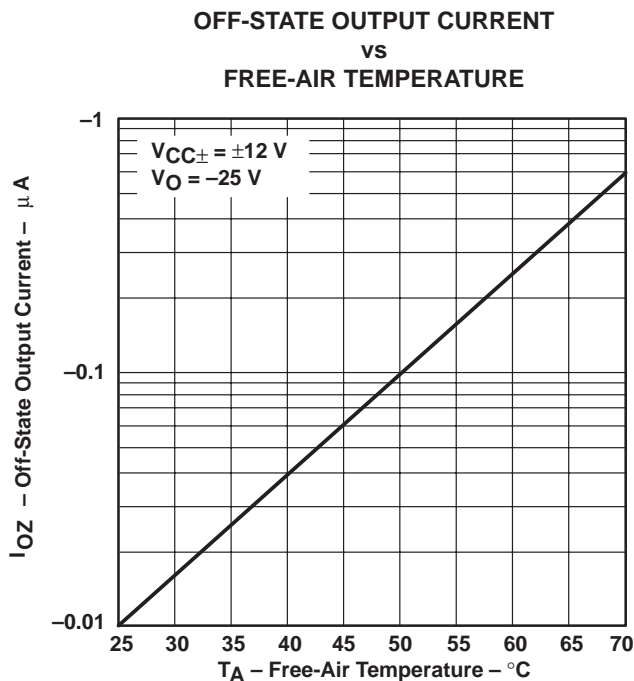


Figure 6

LT1030C QUADRUPLE LOW-POWER LINE DRIVER

SLLS048F – APRIL 1989 – REVISED APRIL 1998

TYPICAL CHARACTERISTICS

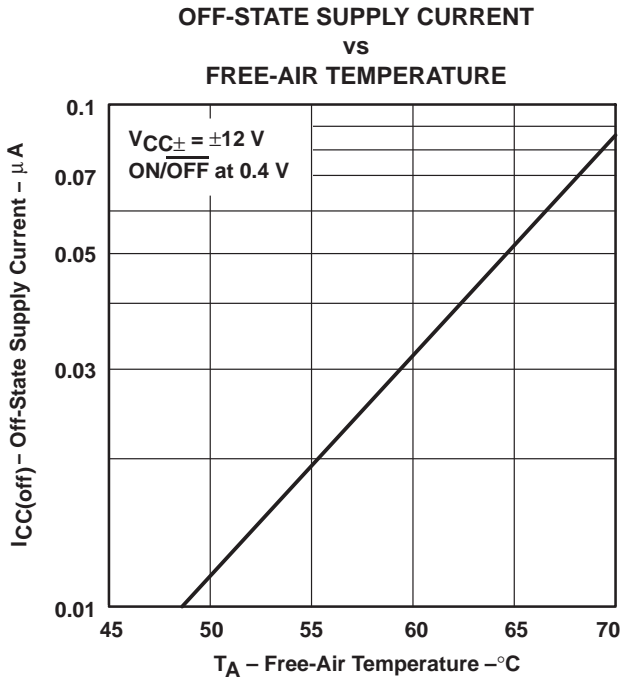


Figure 7

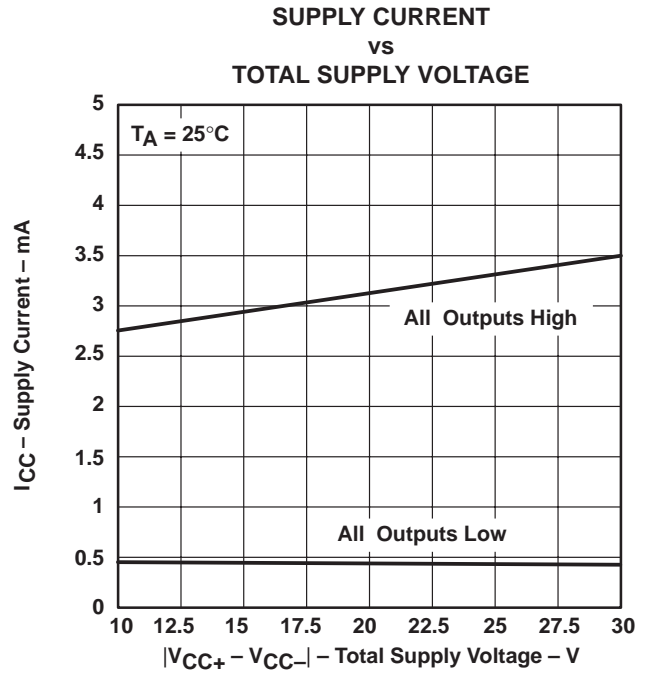


Figure 8

TYPICAL CHARACTERISTICS

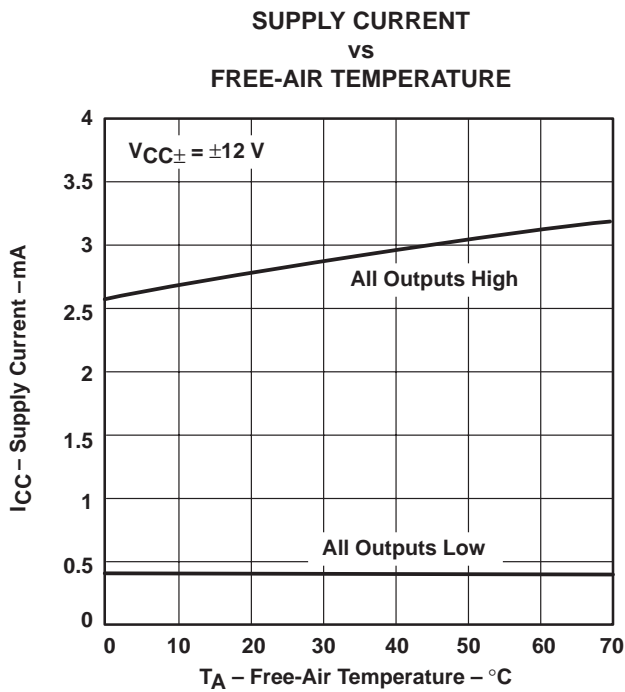


Figure 9

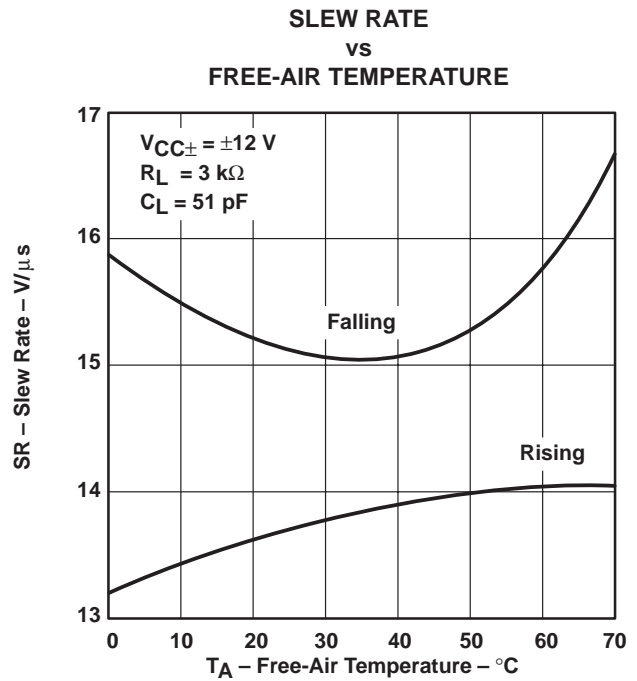


Figure 10



APPLICATION INFORMATION

forward biasing the substrate

As with other bipolar integrated circuits, forward biasing the substrate diode can cause problems. The LT1030C draws high current from V_{CC+} to GND when V_{CC-} is open circuited or pulled above ground. Connecting a diode from V_{CC-} to GND (if possible) prevents the high-current state. Any low-cost diode can be used (see Figure 11).

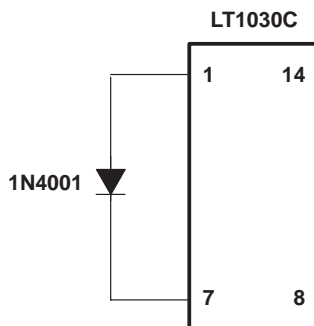


Figure 11. Connecting a Diode From V_{CC-} to GND

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.